SN54ABT16652 . . . WD PACKAGE SN74ABT16652 ... DL PACKAGE (TOP VIEW)

10EAB

SCBS215B - FEBRUARY 1991 - REVISED JANUARY 1997

56 1 10EBA

•	Members of the Texas Instruments
	<i>Widebus</i> ™ Family

- State-of-the-Art EPIC-IIB™ BiCMOS Design Significantly Reduces Power Dissipation
- Latch-Up Performance Exceeds 500 mA Per **JEDEC Standard JESD-17**
- Typical V_{OLP} (Output Ground Bounce) < 1 V at V_{CC} = 5 V, T_A = 25°C
- Distributed V_{CC} and GND Pin Configuration Minimizes High-Speed Switching Noise
- Flow-Through Architecture Optimizes PCB Layout
- High-Drive Outputs (-32-mA I_{OH}, 64-mA I_{OI}) •
- **Package Options Include Plastic 300-mil** • Shrink Small-Outline (DL) Package and 380-mil Fine-Pitch Ceramic Flat (WD) Package Using 25-mil Center-to-Center Spacings

description

The 'ABT16652 are 16-bit bus transceivers that consist of D-type flip-flops and control circuitry arranged for multiplexed transmission of data directly from the data bus or from the internal storage registers. These devices can be used as two 8-bit transceivers or one 16-bit transceiver.

Output-enable (OEAB and OEBA) inputs are provided to control the transceiver functions. Select-control (SAB and SBA) inputs are provided to select whether real-time or stored data is transferred. The circuitry used for select control eliminates the typical decoding glitch that occurs in a multiplexer during the transition between stored and real-time data. A low input selects real-time data, and a high input selects stored data. Figure 1 illustrates the four fundamental bus-management functions that can be pe

performed with the 'ABT16652.
Data on the A- or B-data bus, or both, can be stored in the internal D-type flip-flops by low-to-high transitions at the appropriate clock (CLKAB or CLKBA) inputs regardless of the select- or enable-control inputs. When SAB and SBA are in the real-time transfer mode, it is possible to store data without using the internal D-type flip-flops by simultaneously enabling OEAB and OEBA. In this configuration, each output reinforces its input. When all other data sources to the two sets of bus lines are at high impedance, each set of bus lines remains at its last state.



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

Widebus and EPIC-IIB are trademarks of Texas Instruments Incorporated.

PRODUCTION DATA information is current as of publication date. Products conform to specifications per the terms of Texas Instruments standard warranty. Production processing does not necessarily include testing of all parameters.



1CLKAB	2	55	1CLKBA
1SAB	3	54	1SBA
GND	4	53] GND
1A1 [5	52] 1B1
1A2 [6	51] 1B2
V _{CC} [7	50] V _{CC}
	8	49] 1B3
1A4 [] 1B4
1A5 [10	47	1B5
GND [11	46] GND
1A6 [45] 1B6
1A7 [] 1B7
1A8 [14	43] 1B8
2A1 [15	42	2B1
2A2 🛛	16	41	2B2
2A3 [17	40	2B3
GND [18	39] GND
2A4 [19	38] 2B4
2A5 [20	37	2B5
2A6 [21	36	2B6
V _{CC} [22	35] v _{cc}
	23	34] 2B7
2A8 [24	33	2B8
GND [25	32] GND
2SAB	26		2SBA
2CLKAB	27	30	2CLKBA
20EAB	28	29	20EBA

SCBS215B - FEBRUARY 1991 - REVISED JANUARY 1997

description (continued)

To ensure the high-impedance state during power up or power down, OEBA should be tied to V_{CC} through a pullup resistor; the minimum value of the resistor is determined by the current-sinking capability of the driver (B to A). OEAB should be tied to GND through a pulldown resistor; the minimum value of the resistor is determined by the current-sourcing capability of the driver (A to B).

The SN54ABT16652 is characterized for operation over the full military temperature range of -55°C to 125°C. The SN74ABT16652 is characterized for operation from -40°C to 85°C.

_					10			-
		INP	UTS			DATA	a 1/0†	
OEAB	OEBA	CLKAB	CLKBA	SAB	SBA	A1–A8	B1–B8	OPERATION OR FUNCTION
L	Н	H or L	H or L	Х	Х	Input	Input	Isolation
L	Н	\uparrow	\uparrow	Х	Х	Input	Input	Store A and B data
Х	Н	\uparrow	H or L	Х	Х	Input	Unspecified [‡]	Store A, hold B
н	Н	\uparrow	\uparrow	х‡	Х	Input	Output	Store A in both registers
L	Х	H or L	\uparrow	Х	Х	Unspecified [‡]	Input	Hold A, store B
L	L	\uparrow	\uparrow	х	x‡	Output	Input	Store B in both registers
L	L	Х	Х	Х	L	Output	Input	Real-time B data to A bus
L	L	Х	H or L	Х	Н	Output	Input	Stored B data to A bus
н	Н	Х	Х	L	Х	Input	Output	Real-time A data to B bus
н	Н	H or L	Х	Н	х	Input	Output	Stored A data to B bus
н	L	H or L	H or L	Н	Н	Output	Output	Stored A data to B bus and stored B data to A bus

FUNCTION TABLE

[†] The data-output functions may be enabled or disabled by a variety of level combinations at OEAB or OEBA. Data-input functions are always enabled; i.e., data at the bus terminals is stored on every low-to-high transition of the clock inputs.

[‡]Select control = L; clocks can occur simultaneously.

Select control = H; clocks must be staggered to load both registers.



SCBS215B - FEBRUARY 1991 - REVISED JANUARY 1997

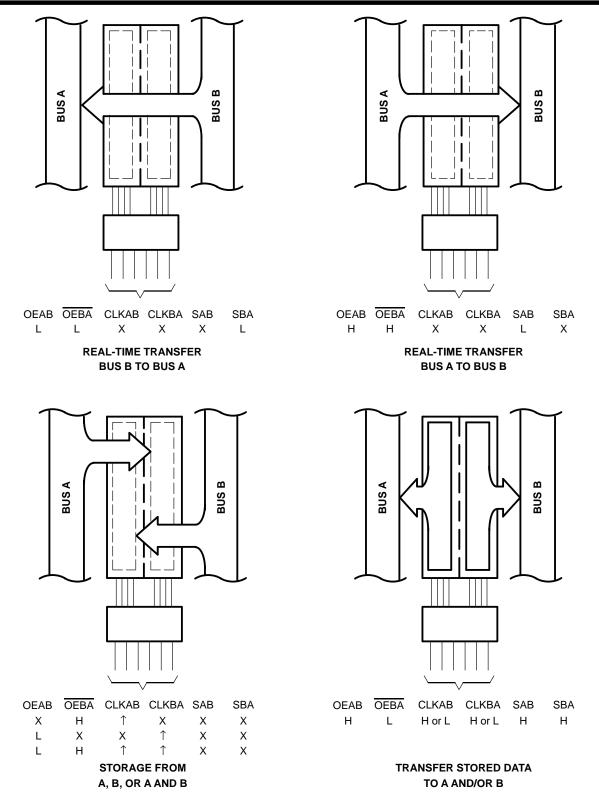
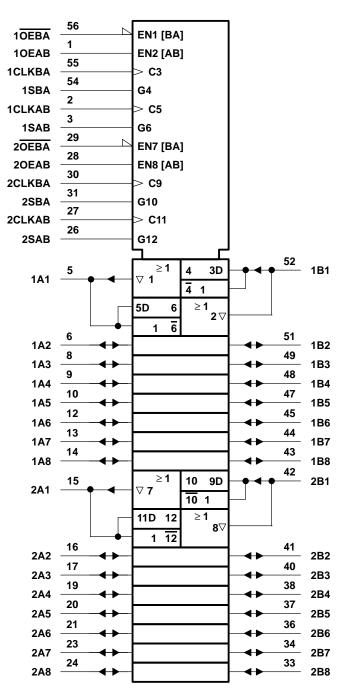


Figure 1. Bus-Management Functions



SCBS215B - FEBRUARY 1991 - REVISED JANUARY 1997

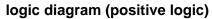
logic symbol[†]

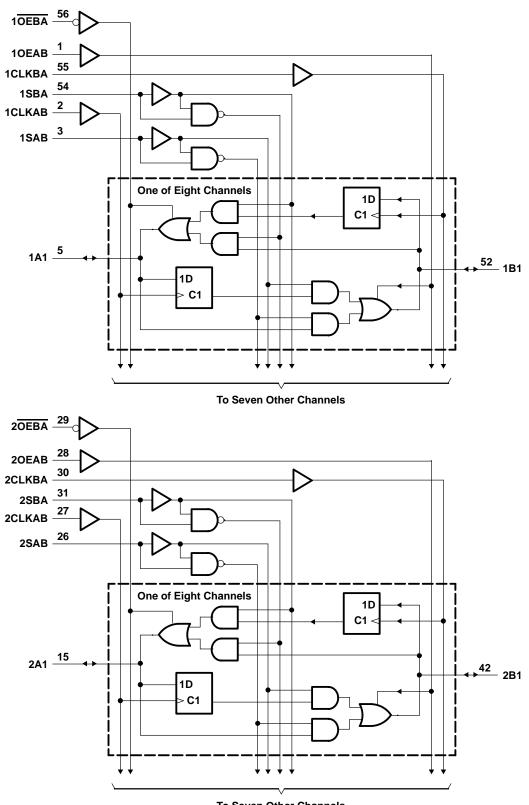


[†] This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.



SCBS215B - FEBRUARY 1991 - REVISED JANUARY 1997





To Seven Other Channels



SCBS215B - FEBRUARY 1991 - REVISED JANUARY 1997

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)[†]

[†] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTES: 1. The input and output negative-voltage ratings may be exceeded if the input and output clamp-current ratings are observed.

2. The package thermal impedance is calculated in accordance with EIA/JEDEC Std JESD51.

recommended operating conditions (see Note 3)

			SN54AB1	16652	SN74AB1	Г16652	UNIT
			MIN	MAX	MIN	MAX	UNIT
VCC	Supply voltage		4.5	5.5	4.5	5.5	V
VIH	High-level input voltage		2		2		V
VIL	Low-level input voltage			0.8		0.8	V
VI	Input voltage		0	VCC	0	VCC	V
IOH	High-level output current			-24		-32	mA
IOL	Low-level output current			48		64	mA
$\Delta t/\Delta v$	Input transition rise or fall rate	Outputs enabled		10		10	ns/V
Τ _Α	Operating free-air temperature		-55	125	-40	85	°C

NOTE 3: Unused pins (input or I/O) must be held high or low to prevent them from floating.



SCBS215B - FEBRUARY 1991 - REVISED JANUARY 1997

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

DAD		TEST CON	Т	A = 25°C	;	SN54AB	Г16652	SN74AB1	UNIT		
PARAMETER		TEST CON		MIN	TYP†	MAX	MIN	MAX	MIN	MAX	UNIT
VIK		V _{CC} = 4.5 V,	lj = -18 mA			-1.2		-1.2		-1.2	V
		V _{CC} = 4.5 V,	I _{OH} = –3 mA	2.5			2.5		2.5		
Maria		V _{CC} = 5 V,	I _{OH} = –3 mA	3			3		3		V
VOH		V _{CC} = 4.5 V	I _{OH} = -24 mA	2			2				v
		VCC = 4.5 V	I _{OH} = -32 mA	2*					2		
Vai			I _{OL} = 48 mA			0.55		0.55			V
VOL		V _{CC} = 4.5 V	I _{OL} = 64 mA			0.55*				0.55	v
V _{hys}					100						mV
lj –	Control inputs	V _{CC} = 5.5 V, V _I = V ₀	CC or GND			±1		±1		±1	μA
	A or B ports					±20		±20		±20	
IOZH‡		V _{CC} = 5.5 V,	V _O = 2.7 V			10		10		10	μA
Iozl‡		V _{CC} = 5.5 V,	$V_{O} = 0.5 V$			-10		-10		-10	μΑ
loff		V _{CC} = 0,	VI or VO \leq 4.5 V			±100				±100	μA
ICEX		V _{CC} = 5.5 V, V _O = 5.5 V	Outputs high			50		50		50	μΑ
۱ ₀ §		V _{CC} = 5.5 V,	V _O = 2.5 V	-50	-100	-180	-50	-180	-50	-180	mA
		V _{CC} = 5.5 V,	Outputs high			2		2		2	
ICC	A or B ports	I _O = 0,	Outputs low			32		32		32	mA
		$V_{I} = V_{CC} \text{ or } GND$	Outputs disabled			2		2		2	
	Data inputs	$V_{CC} = 5.5 V,$ One input at 3.4 V,	Outputs enabled			50		50		50	
∆ICC¶	Data inputs	Other inputs at V _{CC} or GND	Outputs disabled			50		50		50	μA
	Control inputs	$V_{CC} = 5.5 V$, One in Other inputs at V_{CC}				50		50		50	
Ci	Control inputs	V _I = 2.5 V or 0.5 V			4						pF
C _{io}	A or B ports	V _O = 2.5 V or 0.5 V			8						pF

* On products compliant to MIL-PRF-38535, this parameter does not apply.

[†] All typical values are at $V_{CC} = 5 V$.

[‡] The parameters I_{OZH} and I_{OZL} include the input leakage current.

§ Not more than one output should be tested at a time, and the duration of the test should not exceed one second.

This is the increase in supply current for each input that is at the specified TTL voltage level rather than V_{CC} or GND.



SCBS215B - FEBRUARY 1991 - REVISED JANUARY 1997

timing requirements over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted) (see Figure 2)

			SN54AE	T16652				
		V _{CC} = 5 V, T _A = 25°C		V _{CC} = 5 V, T _A = 25°C		MIN	МАХ	UNIT
		MIN	MAX					
fclock	Clock frequency	0	125	0	125	MHz		
tw	Pulse duration, CLK high or low	4.3		4.3		ns		
t _{su}	Setup time, A or B before CLKAB↑ or CLKBA↑	3.5		4		ns		
^t h	Hold time, A or B after CLKAB↑ or CLKBA↑	0.5		0.5		ns		

timing requirements over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted) (see Figure 2)

			SN74AE	BT16652				
		V _{CC} = 5 V, T _A = 25°C		V _{CC} = 5 V, T _A = 25°C		V _{CC} = 5 V, T _A = 25°C MIN		UNIT
		MIN	MAX					
fclock	Clock frequency	0	125	0	125	MHz		
tw	Pulse duration, CLK high or low	4.3		4.3		ns		
t _{su}	Setup time, A or B before CLKAB↑ or CLKBA↑	3		3		ns		
t _h	Hold time, A or B after CLKAB↑ or CLKBA↑	0		0		ns		



SCBS215B - FEBRUARY 1991 - REVISED JANUARY 1997

switching characteristics over recommended ranges of supply voltage and operating free-air temperature, $C_L = 50 \text{ pF}$ (unless otherwise noted) (see Figure 2)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	V ₀ T	CC = 5 V A = 25°C	/, ;	MIN	МАХ	UNIT
			MIN	TYP	MAX			
f _{max}			125			125		MHz
^t PLH	CLK	B or A	1.5	3.1	4	1	5	ns
^t PHL	ULK	BUR	1.5	3.2	4.1	1	5	115
^t PLH	A or B	B or A	1	2.3	3.2	0.6	4	ns
^t PHL	AUB	BUIA	1	3	4.1	0.6	4.9	115
^t PLH	040 004	B or A	1	2.9	4.3	0.6	5.3	ns
^t PHL	SAB or SBA†	BUR	1	3.1	4.6	0.6	5.3	115
^t PZH	OEBA	А	1	2.8	4.1	0.6	5.2	ns
^t PZL	OEBA	~	1.5	3.1	4.4	1	5.4	115
^t PHZ	OEBA	А	1.5	3.4	4.7	0.8	5.3	ns
^t PLZ	OEBA	~	1.5	2.7	4	1	5.3	115
^t PZH		В	1	2.6	3.6	0.8	4.7	ns
^t PZL	OEAB	D	1.5	2.8	4.5	1	5	115
^t PHZ	0540	В	2	4.2	5.9	1	6.4	
^t PLZ	OEAB		1.5	3.4	4.9	1	5.9	ns

[†] These parameters are measured with the internal output state of the storage register opposite that of the bus input.

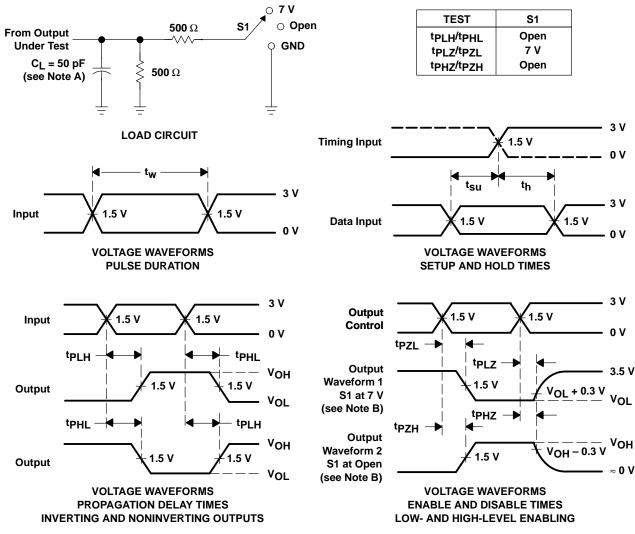
switching characteristics over recommended ranges of supply voltage and operating free-air temperature, $C_L = 50 \text{ pF}$ (unless otherwise noted) (see Figure 2)

		TO (OUTPUT)						
PARAMETER	FROM (INPUT)		V _{CC} = 5 V, T _A = 25°C			MIN	MAX	UNIT
			MIN	TYP	MAX			
fmax			125			125		MHz
^t PLH	CLK	B or A	1.5	3.1	4	1.5	4.9	ns
^t PHL	ULK	BUIA	1.5	3.2	4.1	1.5	4.7	115
^t PLH	A or B	B or A	1	2.3	3.2	1	3.9	ns
^t PHL	AUID	BUIA	1	3	4.1	1	4.6	115
^t PLH	040 004t	B or A	1	2.9	4.3	1	5	
^t PHL	SAB or SBA [†]	BUIA	1	3.1	4.3	1	5	ns
^t PZH			1	2.8	4.1	1	5	
^t PZL	OEBA	А	1.5	3.1	4.4	1.5	5.3	ns
^t PHZ	0554	А	1.5	3.4	4.4	1.5	4.9	
^t PLZ	OEBA	A	1.5	2.7	3.6	1.5	4	ns
^t PZH	OFAD	В	1	2.6	3.6	1	4.2	20
^t PZL	OEAB	В	1.5	2.8	3.9	1.5	4.6	ns
^t PHZ	0545	В	2	4.2	5.5	2	5.9	
^t PLZ	OEAB	В	1.5	3.4	4.5	1.5	5.2	ns

[†] These parameters are measured with the internal output state of the storage register opposite that of the bus input.



SCBS215B – FEBRUARY 1991 – REVISED JANUARY 1997



PARAMETER MEASUREMENT INFORMATION

NOTES: A. CL includes probe and jig capacitance.

B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.

C. All input pulses are supplied by generators having the following characteristics: PRR \leq 10 MHz, Z_O = 50 Ω , t_f \leq 2.5 ns, t_f \leq 2.5 ns.

D. The outputs are measured one at a time with one transition per measurement.

Figure 2. Load Circuit and Voltage Waveforms



IMPORTANT NOTICE

Texas Instruments (TI) reserves the right to make changes to its products or to discontinue any semiconductor product or service without notice, and advises its customers to obtain the latest version of relevant information to verify, before placing orders, that the information being relied on is current.

TI warrants performance of its semiconductor products and related software to the specifications applicable at the time of sale in accordance with TI's standard warranty. Testing and other quality control techniques are utilized to the extent TI deems necessary to support this warranty. Specific testing of all parameters of each device is not necessarily performed, except those mandated by government requirements.

Certain applications using semiconductor products may involve potential risks of death, personal injury, or severe property or environmental damage ("Critical Applications").

TI SEMICONDUCTOR PRODUCTS ARE NOT DESIGNED, INTENDED, AUTHORIZED, OR WARRANTED TO BE SUITABLE FOR USE IN LIFE-SUPPORT APPLICATIONS, DEVICES OR SYSTEMS OR OTHER CRITICAL APPLICATIONS.

Inclusion of TI products in such applications is understood to be fully at the risk of the customer. Use of TI products in such applications requires the written approval of an appropriate TI officer. Questions concerning potential risk applications should be directed to TI through a local SC sales office.

In order to minimize risks associated with the customer's applications, adequate design and operating safeguards should be provided by the customer to minimize inherent or procedural hazards.

TI assumes no liability for applications assistance, customer product design, software performance, or infringement of patents or services described herein. Nor does TI warrant or represent that any license, either express or implied, is granted under any patent right, copyright, mask work right, or other intellectual property right of TI covering or relating to any combination, machine, or process in which such semiconductor products or services might be or are used.

Copyright © 1996, Texas Instruments Incorporated